Docket No.: 065933-0084

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Customer Number: 20277

Ryosuke USUI, et al.

Confirmation Number: 3812

Application No.: 10/813,629

Group Art Unit: 2814

Filed: March 31, 2004

Examiner: Dilinh P. Nguyen

For: SEMICONDUCTOR MODULE AND METHOD OF MANUFACTURING THE SAME

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

Each non-English language reference was first cited in a corresponding foreign application search report or office action and its relevance discussed therein. A copy of the

10/813,629

foreign search report or office action, together with an English language version thereof, is attached for the Examiner's information.

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

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Facsimile: 202.756.8087 **Date: January 31, 2006**

Please recognize our Customer No. 20277 as our correspondence address.

SHEET 1 OF 1

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					APPLICANT Ryosuke USUI,	APPLICANT Ryosuke USUI, et al.					
(PTO-1449)					FILING DATE March 31, 2004						
U.S. PATENT DOCUMENTS											
EXAMINER'S INITIALS	CITE NO.	Document Number Number-Kind Code2 (# known)		Publication Dat MM-DD-YYYY			Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear				
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Notification of Reasons for Rejection; Dispatch Date: October 31, 2005; Patent Application No. 10-2004-21647; Ti Semiconductor Module and Method of Manufacturing the Same								21647; Title			
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EXAMINER						DATE CONSIDERED					

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.